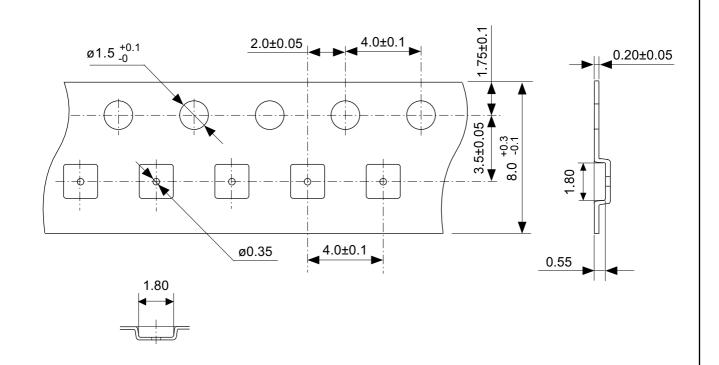
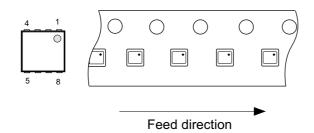


The heat sink of back side has different electric potential depending on the product.
Confirm specifications of each product.
Do not use it as the function of electrode.

No. PY008-A-P-SD-1.0

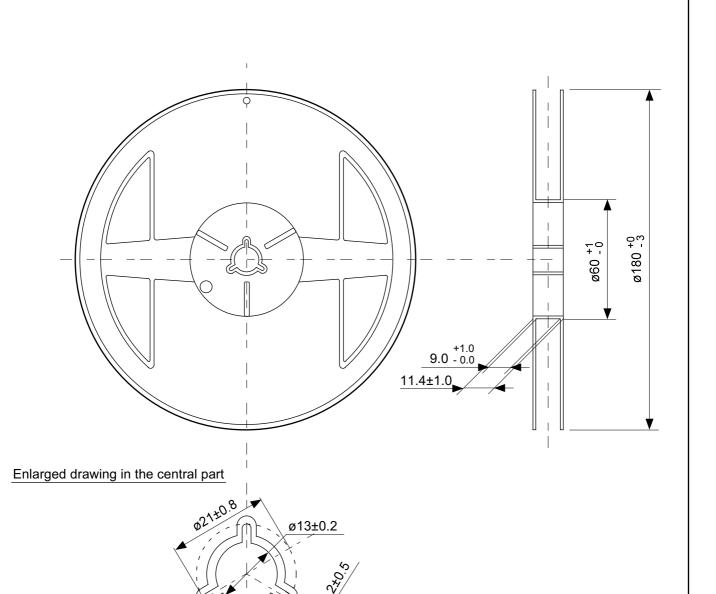
TITLE	HSNT-8-B-PKG Dimensions					
No.	PY008-A-P-SD-1.0					
ANGLE	♦ €3					
UNIT	mm					
ABLIC Inc.						





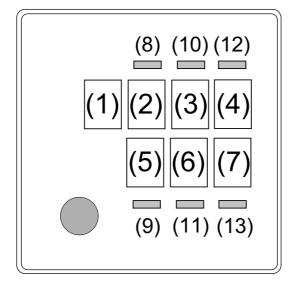
No. PY008-A-C-SD-1.0

TITLE	HSNT-8-B-Carrier Tape				
No.	PY008-A-C-SD-1.0				
ANGLE					
UNIT	mm				
ABLIC Inc.					



No. PY008-A-R-SD-1.0

TITLE	HSNT-8-B-Reel			
No.	PY008-A-R-SD-1.0			
ANGLE		QTY.	5,000	
UNIT	mm			
·				
ABLIC Inc.				



(1) to (4) : Product code

(5) to (7) : Lot No.

(8), (9) : Year of assembly (bar)

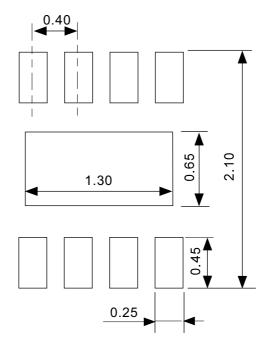
(10) to (13): Month of assembly (bar)

: 1 Pin mark

No. PY008-A-M-SD-1.0

TITLE	HSNT-8-B-Markings			
No.	PY008-A-M-SD-1.0			
ANGLE				
UNIT		TYPE	LASER	
ABLIC Inc.				

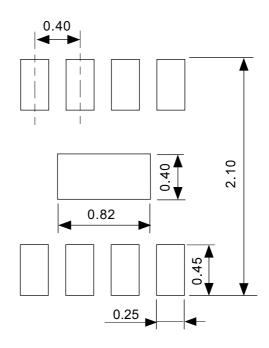
Land Pattern



Caution It is recommended to solder the heat sink to a board in order to ensure the heat radiation.

放熱性を確保する為に、PKGの裏面放熱板(ヒートシンク)を基板に 注意 半田付けする事を推奨いたします。

Metal Mask Pattern



- Caution ① Mask aperture ratio of the lead mounting part is 100%.
 - 2 Mask aperture ratio of the heat sink mounting part is 40%.
 - 3 Mask thickness: t0.12 mm

注意 ①リード実装部のマスク開口率は100%です。

- ②放熱板実装のマスク開口率は40%です。
- ③マスク厚み: t0.12 mm

ANGLE	
UNIT	mm

HSNT-8-B

-Land Recommendation

PY008-A-L-SD-1.0

TITLE

No.

No. PY008-A-L-SD-1.0

Α	B	ı	ı	C	1	n	C	_